You are cordially invited to join us at the 37th Annual International Conference of the IEEE Engineering in Medicine and Biology Society, EMBC’15. This prestigious event is the world’s largest annual Biomedical Engineering forum, and will be held 25-29 August 2015 at the Milano Conference Center in Milan, Italy.

The general theme of EMBC’15 is “Biomedical Engineering: a Bridge to improve the Quality of Health Care and the Quality of Life”, covering diverse topics from cutting-edge biomedical and healthcare technology research and development, clinical applications, to biomedical education. The conference program will consist of high-profile plenary/keynote lectures, symposia, workshops, invited sessions, oral and poster sessions, and exhibitions. All papers will be peer reviewed; accepted full-length (4 page) papers will appear in the Conference Proceedings and be indexed by IEEE Xplore and Medline/PubMed.

Please note that this invitation for participation does not, in any way, financially oblige either EMBC’15 or the IEEE Engineering in Medicine and Biology Society (EMBS) for the expenses you incur for travel and conference attendance, and all conference participants are expected to pay the registration fees according to conference policy. You will have access to a more customized Invitation letter (to include your name and paper information) once your paper has been accepted.

Please visit http://embc.embs.org/2015/ to learn more. We look forward to your participation in EMBC’15!

Sincerely,

Sergio Cerutti
EMBC’15 Conference Chair